

2.0x1.25x0.8mm Flashing Chip LED 1.5Hz 1/2 Duty Cycle

OSX50805C1S

Features

•Outline Dimension

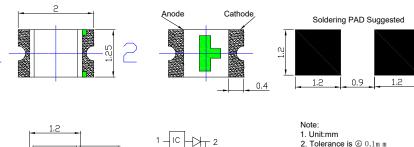
- Single chip flashing Type
- 2.0x1.25x0.8mm(0805) standard package.
- Suitable for all SMT assembly methods.
- Compatible with infrared and vapor phase reflow solder process.
- This product doesn't contain restriction Substance, comply ROHS standard.
- Compatible with automatic placement equipment.

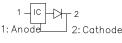
Applications

Automotive: Dashboards, stop lamps, turn signals.

Backlighting: LCDs, Key pads advertising.

■Absolute Maximum Rating		(Ta=25℃)		
Item	Symbol	Value	Unit	
Power Supply	Voltage	5	V	
Duty Cycle	Duty	1/2	-	
Operating Temperature	Topr	$-40 \sim +85$	°C	
Storage Temperature	Tstg	-40~+85	°C	
Lead Soldering Temperature	Tsol	260°C/10sec	-	



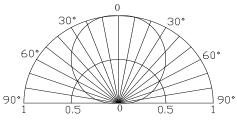


0'8

0.2



Directivity



Electrical -Optical Characteristics

2θ1/2(deg) $V_F(V)$ Fled (Hz) Iv(mcd) $\lambda D(nm)/CCT(K)$ Typ. Max. Part Number Color Min. Тур. Max. Тур. Min. Min. Typ. Max. Typ. I_F=20mA OSW50805C1S White W 3.0 3.5 1.5 330 CCT: 7000-20000K 5.0 120 _ _ OSM50805C1S Warm White М 3.5 5.0 1.5 330 CCT: 2500-3500K 3.0 120 _ _ Κ OSK50805C1S Pink 3.0 3.5 5.0 1.5 150 X:0.32~0.38, Y:0.12~0.18 120 _ _ OSB50805C1S Blue В 3.0 3.5 5.0 1.5 100 460 465 470 120 _ _ Pure Green PG 3.0 5.0 1.5 400 120 OSG50805C1S 3.5 520 525 530 _ _ OSG80805C1S Yellow Green YG 3.0 3.5 1.5 45 570 5.0 _ _ 565 575 120 OSY50805C1S Yellow Y 3.0 3.5 5.0 1.5 100 585 590 595 120 _ _ OSO50805C1S 0 3.0 3.5 5.0 1.5 100 600 610 120 Orange 605 _ _ Red 3.5 5.0 625 OSR50805C1S R 3.0 1.5 100 620 630 120 _ _

(Ta=25°C)

Note: *1 Tolerance of measurements of color temperature is ±10%

*2 Tolerance of measurements of dominant wavelength is +1nm

*3 Tolerance of measurements of luminous intensity is $\pm 15\%$

*4 Tolerance of measurements of forward voltage is±0.1V

*5. Tolerance of measurements of Frequency is +20%

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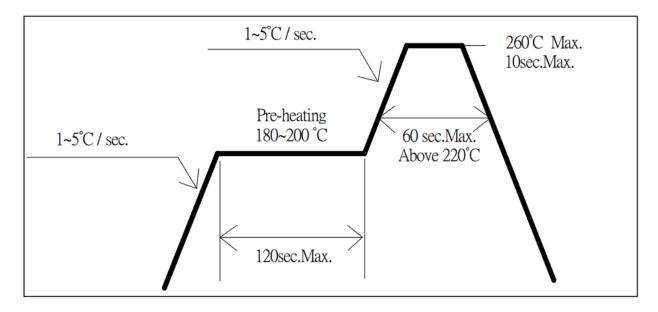


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Soldering Conditions

Reflow Soldering		Ha	Hand Soldering	
Pre-Heat	$180 \sim 200^{\circ} C$			
Pre-Heat Time	120 sec. Max.		350°C Max. 3 sec. Max.	
Peak Temperature	260°C Max.	Temperature		
Dipping Time	10 sec. Max.	Soldering time		
Condition	Refer to Temperature-profile		(one time only)	

• Reflow Soldering Condition(Lead-free Solder)



*Recommended soldering conditions vary according to the type of LED

*Although the recommended soldering conditions are specified in the above table, reflow, or hand soldering at the lowest possible temperature is desirable for the LEDs.

*A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.

•All SMD LED products are pb-free soldering available.

• Occasionally there is a brightness decrease caused by the influence of heat or ambient atmosphere during air reflow. It is recommended that the User use the nitrogen reflow method.

• Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable

double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

- Reflow soldering should not be done more than two times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.



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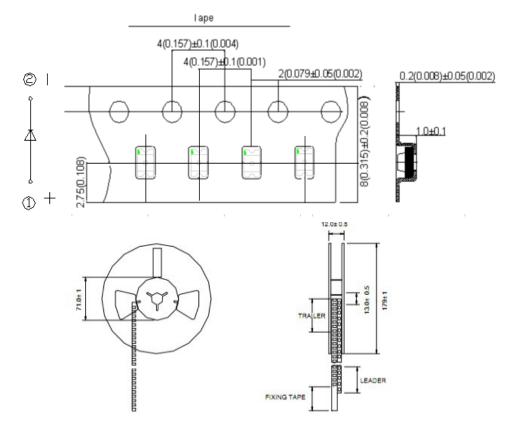


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Taping and Orientation

- 1. Quantity: 3000pcs/Reel
- 2. Note: The tolerances unless mentioned is ± 0.1 mm, unit: mm



Cautions:

1. After open the package, the LED's floor life is 4 Weeks under 30°C or less and 60%RH or less(MSL:2a).

2. Heat generation must be taken into design consideration when using the LED.

3. Power must be applied resistors for protection, over current would be caused the optic damage to the devices and wavelength shift.

4. Manual tip solder may cause the damage to Chip devices, so advised that heat of iron should be lower than 15W with temperature control under 5 seconds at 230-260 deg. C.

(The device would be got damage in re working process, recommended under 5 seconds at 230-260 deg. C)

5. All equipment and machinery must be properly grounded. It is recommended to use a wristband or anti-electrostatic glove when handing the LED.

6. Use IPA as a solvent for cleaning the LED. The other solvent may dissolve the LED package and the epoxy, Ultrasonic cleaning should not be done.

7. Damaged LED will show unusual characteristics such as leak current remarkably increase, turn-on voltage becomes lower and the LED get unlight at low current.

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